

Amendments to the Claims:

The listing of claims will replace all prior versions and listings of claims in the application:

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Listing of Claims:

Claim 1 (currently amended): A liquid crystal display module comprising:

10 a glass substrate having a display area and a peripheral area, a plurality of scan lines and a plurality of data lines is separately formed on the display area along horizontal and vertical directions;

15 at least a gate driver chip mounted directly on the peripheral area of the glass substrate with an anisotropic conductive film or a non-conductive film, the gate driver chip transmits signals to the scan lines via a plurality of output terminals, thickness of the gate driver chip is less than ~~0.3 mm~~ 0.15 mm, and the gate driver chip is thinned to reduce the stress created between the gate driver chip and the glass substrate; and

20 at least a source driver chip mounted directly on the peripheral area of the glass substrate with the anisotropic conductive film or the non-conductive film, the source driver chip transmits signals to the data lines via a plurality of output terminals, and thickness of the source driver chip is less than ~~0.3 mm~~ 0.15 mm, and the source driver chip is thinned to reduce the stress created between the source driver chip and the glass substrate.

25 Claim 2 (canceled)

Claim 3 (canceled)

Claim 4 (canceled)

30 Claim 5 (original): The liquid crystal display module of claim 1 further comprising at

least a flexible printed circuit board mounted on the peripheral area.

Claims 6-12 (canceled)

- 5 Claim 13 (currently amended): A liquid crystal display module comprising:
 a glass substrate having a display area and a peripheral area, and a plurality of
 wires formed on the display area along horizontal and vertical directions; and
 at least a driver chip mounted directly on the peripheral area of the glass substrate
 with an anisotropic conductive film or a non-conductive film, wherein the thickness of
10 the driver chip is less than ~~0.3 mm~~ 0.15 mm and the driver chip is thinned to reduce
 the stress created between the chip and the glass substrate.

Claim 14 (canceled)

- 15 Claim 15 (canceled)

Claim 16 (previously presented): The liquid crystal display module of claim 13 further
comprising at least a flexible printed circuit board mounted on the peripheral area.

- 20 Claim 17 (previously presented): The liquid crystal display module of claim 13,
 wherein the wires comprise scan lines and data lines.

- Claim 18 (previously presented): The liquid crystal display module of claim 17,
 wherein the driver chip is a gate driver chip, such that the gate driver chip transmits
25 signals to the scan lines via a plurality of output terminals.

 Claim 19 (previously presented): The liquid crystal display module of claim 17,
 wherein the driver chip is a source driver chip, such that the source driver chip
transmits signals to the data lines via a plurality of output terminals.

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Claim 20 (previously presented): The liquid crystal display module of claim 1,
wherein the gate driver chip is bendable.

Claim 21 (previously presented): The liquid crystal display module of claim 1,
5 wherein the source driver chip is bendable.